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# HEF4014B-Q100

# 8-bit static shift register

Rev. 1 — 27 February 2013

**Product data sheet** 

## 1. General description

The HEF4014B-Q100 is a fully synchronous edge-triggered 8-bit static shift register with eight synchronous parallel inputs (D0 to D7). It has a synchronous serial data input (DS), a synchronous parallel enable input (PE) and a LOW-to-HIGH edge-triggered clock input (CP). It also has buffered parallel outputs from the last three stages (Q5 to Q7).

Operation is synchronous and the device is edge-triggered on the LOW-to-HIGH transition of CP. Each register stage is of a D-type master-slave flip-flop type. When PE is HIGH, data is loaded into the register from D0 to D7 on the LOW-to-HIGH transition of CP. When PE is LOW, data is shifted to the first position from DS. All the data in the register is shifted one position to the right on the LOW-to-HIGH transition of CP. The Schmitt trigger action of the clock input makes the HEF4014B-Q100 highly tolerant of slower clock rise and fall times.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - ◆ Specified from -40 °C to +85 °C
- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- ESD protection:
  - ◆ MIL-STD-833, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Complies with JEDEC standard JESD 13-B

# 3. Applications

- Parallel-to-serial converter
- Serial data queueing
- General-purpose register



# 4. Ordering information

### Table 1. Ordering information

All types operate from −40 °C to +85 °C

| Type number    | Package | ıckage   |          |  |  |  |
|----------------|---------|--|----------|--|--|--|
|                | Name    | Description  | Version  |  |  |  |
| HEF4014BT-Q100 | SO16    | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |  |  |  |

# 5. Functional diagram

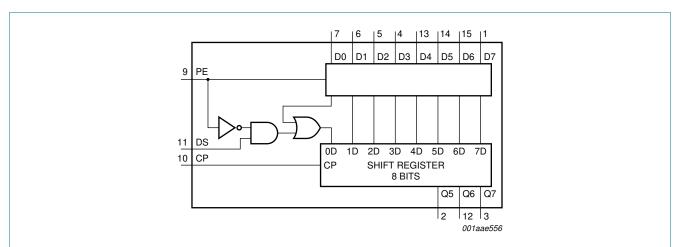
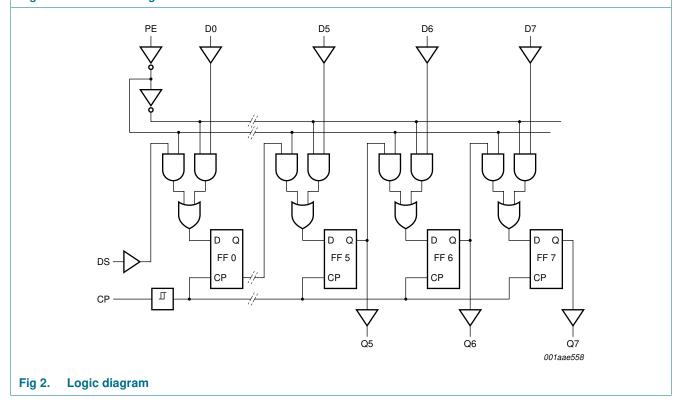
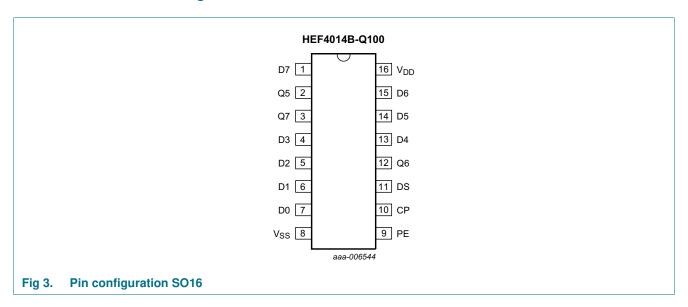


Fig 1. Functional diagram



# 6. Pinning information

## 6.1 Pinning



## 6.2 Pin description

Table 2. Pin description

| Symbol          | Pin                       | Description                              |
|-----------------|---------------------------|--|
| Q5 to Q7        | 2, 12, 3                  | output                                   |
| D0 to D7        | 7, 6, 5, 4, 13, 14, 15, 1 | parallel data input                      |
| V <sub>SS</sub> | 8                         | ground supply voltage                    |
| PE              | 9                         | parallel enable input                    |
| СР              | 10                        | clock input (LOW-to-HIGH edge-triggered) |
| DS              | 11                        | serial data input                        |
| $V_{DD}$        | 16                        | supply voltage                           |

# 7. Functional description

Table 3. Function table[1]

| Number of clock    | Inputs       |    |    | Outputs   | Outputs   |           |  |
|--------------------|--------------|----|----|-----------|-----------|-----------|--|
| transitions        | СР           | DS | PE | Q5        | Q6        | Q7        |  |
| Serial operation   |              | '  | '  | '         |           | '         |  |
| 1                  | <b>↑</b>     | 1D | L  | Χ         | X         | Χ         |  |
| 2                  | <b>↑</b>     | 2D | L  | Χ         | X         | Χ         |  |
| 3                  | <b>↑</b>     | 3D | L  | Χ         | X         | Χ         |  |
| 6                  | <b>↑</b>     | Х  | L  | 1D        | X         | Χ         |  |
| 7                  | <b>↑</b>     | Х  | L  | 2D        | 1D        | Χ         |  |
| 8                  | <b>↑</b>     | Х  | L  | 3D        | 2D        | 1D        |  |
|                    | $\downarrow$ | X  | X  | no change | no change | no change |  |
| Parallel operation |              |    |    |           |           |           |  |
| 1                  | <b>↑</b>     | Х  | Н  | D5        | D6        | D7        |  |
|                    | $\downarrow$ | X  | X  | no change | no change | no change |  |

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care; nD = HIGH or LOW;

# 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions  | Min          | Max            | Unit |
|------------------|-------------------------|---|--------------|----------------|------|
| $V_{DD}$         | supply voltage          |   | -0.5         | +18            | V    |
| I <sub>IK</sub>  | input clamping current  | $V_I < -0.5 \text{ V or } V_I > V_{DD} + 0.5 \text{ V}$             | -            | ±10            | mA   |
| VI               | input voltage           |   | -0.5         | $V_{DD} + 0.5$ | V    |
| I <sub>OK</sub>  | output clamping current | $V_{O} < -0.5 \text{ V or } V_{O} > V_{DD} + 0.5 \text{ V}$         | -            | ±10            | mA   |
| I <sub>I/O</sub> | input/output current    |   | -            | ±10            | mA   |
| $I_{DD}$         | supply current          |   | -            | 50             | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65          | +150           | °C   |
| T <sub>amb</sub> | ambient temperature     |   | -40          | +85            | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +85  ^{\circ}\text{C}$ | <u>[1]</u> _ | 500            | mW   |
| Р                | power dissipation       | per output  | -            | 100            | mW   |

<sup>[1]</sup> For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

 $<sup>\</sup>uparrow$  = LOW-to-HIGH clock transition;  $\downarrow$  = HIGH-to-LOW clock transition;

# 9. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol              | Parameter                           | Conditions              | Min | Тур | Max      | Unit |
|---------------------|-------------------------------------|-------------------------|-----|-----|----------|------|
| $V_{DD}$            | supply voltage                      |                         | 3   | -   | 15       | V    |
| V <sub>I</sub>      | input voltage                       |                         | 0   | -   | $V_{DD}$ | V    |
| T <sub>amb</sub>    | ambient temperature                 | in free air             | -40 | -   | +85      | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{DD} = 5 V$          | -   | -   | 3.75     | μs/V |
|                     |                                     | $V_{DD} = 10 \text{ V}$ | -   | -   | 0.5      | μs/V |
|                     |                                     | V <sub>DD</sub> = 15 V  | -   | -   | 0.08     | μs/V |

# 10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0 \ V$ ;  $V_{I} = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

| Symbol          | nbol Parameter Conditions | Conditions               | s V <sub>DD</sub> | T <sub>amb</sub> = | –40 °C | T <sub>amb</sub> = | +25 °C | T <sub>amb</sub> = | +85 °C | Unit |
|-----------------|---------------------------|--------------------------|-------------------|--------------------|--------|--------------------|--------|--------------------|--------|------|
|                 |                           |                          |                   | Min                | Max    | Min                | Max    | Min                | Max    |      |
| V <sub>IH</sub> | HIGH-level input voltage  | $ I_{O}  < 1 \mu A$      | 5 V               | 3.5                | -      | 3.5                | -      | 3.5                | -      | V    |
|                 |                           |                          | 10 V              | 7.0                | -      | 7.0                | -      | 7.0                | -      | V    |
|                 |                           |                          | 15 V              | 11.0               | -      | 11.0               | -      | 11.0               | -      | V    |
| $V_{IL}$        | LOW-level input voltage   | $ I_O  < 1 \mu A$        | 5 V               | -                  | 1.5    | -                  | 1.5    | -                  | 1.5    | V    |
|                 |                           |                          | 10 V              | -                  | 3.0    | -                  | 3.0    | -                  | 3.0    | V    |
|                 |                           |                          | 15 V              | -                  | 4.0    | -                  | 4.0    | -                  | 4.0    | V    |
| $V_{OH}$        | HIGH-level output voltage | $ I_O  < 1 \mu A$        | 5 V               | 4.95               | -      | 4.95               | -      | 4.95               | -      | V    |
|                 |                           |                          | 10 V              | 9.95               | -      | 9.95               | -      | 9.95               | -      | V    |
|                 |                           |                          | 15 V              | 14.95              | -      | 14.95              | -      | 14.95              | -      | V    |
| $V_{OL}$        | LOW-level output voltage  | $ I_O  < 1 \mu A$        | 5 V               | -                  | 0.05   | -                  | 0.05   | -                  | 0.05   | V    |
|                 |                           |                          | 10 V              | -                  | 0.05   | -                  | 0.05   | -                  | 0.05   | V    |
|                 |                           |                          | 15 V              | -                  | 0.05   | -                  | 0.05   | -                  | 0.05   | V    |
| I <sub>OH</sub> | HIGH-level output current | $V_{O} = 2.5 \text{ V}$  | 5 V               | -                  | -1.7   | -                  | -1.4   | -                  | -1.1   | mΑ   |
|                 |                           | $V_{O} = 4.6 \text{ V}$  | 5 V               | -                  | -0.52  | -                  | -0.44  | -                  | -0.36  | mΑ   |
|                 |                           | $V_{O} = 9.5 \text{ V}$  | 10 V              | -                  | -1.3   | -                  | -1.1   | -                  | -0.9   | mΑ   |
|                 |                           | $V_{O} = 13.5 \text{ V}$ | 15 V              | -                  | -3.6   | -                  | -3.0   | -                  | -2.4   | mΑ   |
| I <sub>OL</sub> | LOW-level output current  | $V_{O} = 0.4 \text{ V}$  | 5 V               | 0.52               | -      | 0.44               | -      | 0.36               | -      | mA   |
|                 |                           | $V_{O} = 0.5 \text{ V}$  | 10 V              | 1.3                | -      | 1.1                | -      | 0.9                | -      | mA   |
|                 |                           | V <sub>O</sub> = 1.5 V   | 15 V              | 3.6                | -      | 3.0                | -      | 2.4                | -      | mA   |
| I <sub>I</sub>  | input leakage current     |                          | 15 V              | -                  | ±0.3   | -                  | ±0.3   | -                  | ±1.0   | μА   |
| I <sub>DD</sub> | supply current            | $I_O = 0 A$              | 5 V               | -                  | 20     | -                  | 20     | -                  | 150    | μА   |
|                 |                           |                          | 10 V              | -                  | 40     | -                  | 40     | -                  | 300    | μА   |
|                 |                           |                          | 15 V              | -                  | 80     | -                  | 80     | -                  | 600    | μА   |
| Cı              | input capacitance         |                          | -                 | -                  | -      | -                  | 7.5    | -                  | -      | pF   |

# 11. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = 25$  °C;  $V_{SS} = 0$  V.

| Symbol                | Parameter         | Conditions                        | $V_{DD}$                           | Extrapolation formula[1]             | Min | Тур | Max | Unit |
|-----------------------|-------------------|-----------------------------------|------------------------------------|--------------------------------------|-----|-----|-----|------|
| t <sub>PHL</sub>      | HIGH to LOW       | CP to Qn;                         | 5 V                                | 103 ns + $(0.55 \text{ ns/pF})C_L$   | -   | 130 | 260 | ns   |
| propagation delay     | see Figure 4      | 10 V                              | 44 ns + (0.23 ns/pF)C <sub>L</sub> | -                                    | 55  | 110 | ns  |      |
|                       |                   |                                   | 15 V                               | 32 ns + (0.16 ns/pF)C <sub>L</sub>   | -   | 40  | 80  | ns   |
| t <sub>PLH</sub>      | LOW to HIGH       | CP to Qn;                         | 5 V                                | 88 ns + (0.55 ns/pF)C <sub>L</sub>   | -   | 115 | 230 | ns   |
|                       | propagation delay | see Figure 4                      | 10 V                               | 39 ns + (0.23 ns/pF)C <sub>L</sub>   | -   | 50  | 100 | ns   |
|                       |                   |                                   | 15 V                               | 32 ns + (0.16 ns/pF)C <sub>L</sub>   | -   | 40  | 80  | ns   |
| t <sub>t</sub>        | transition time   | Qn output;                        | 5 V                                | 2 10 ns + (1.00 ns/pF)C <sub>L</sub> | -   | 60  | 120 | ns   |
|                       |                   | see Figure 4                      | 10 V                               | 9 ns + (0.42 ns/pF)C <sub>L</sub>    | -   | 30  | 60  | ns   |
|                       |                   |                                   | 15 V                               | 6 ns + (0.28 ns/pF)C <sub>L</sub>    | -   | 20  | 40  | ns   |
| t <sub>W</sub>        | pulse width       | CP input;                         | 5 V                                |                                      | 70  | 35  | -   | ns   |
|                       |                   | minimum width;                    | 10 V                               |                                      | 30  | 15  | -   | ns   |
|                       |                   | see Figure 5                      | 15 V                               |                                      | 24  | 12  | -   | ns   |
| t <sub>su</sub>       | set-up time       |                                   | 5 V                                |                                      | 40  | 10  | -   | ns   |
|                       |                   | see Figure 5                      | 10 V                               |                                      | 25  | 5   | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 15  | 0   | -   | ns   |
|                       |                   | DS → CP;<br>see <u>Figure 5</u>   | 5 V                                |                                      | +35 | -5  | -   | ns   |
|                       |                   |                                   | 10 V                               |                                      | +25 | -5  | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 25  | 0   | -   | ns   |
|                       |                   | $Dn \rightarrow CP;$ see Figure 5 | 5 V                                |                                      | +35 | -5  | -   | ns   |
|                       |                   |                                   | 10 V                               |                                      | +25 | -5  | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 25  | 0   | -   | ns   |
| t <sub>h</sub>        | hold time         | $PE \rightarrow CP;$              | 5 V                                |                                      | +25 | -5  | -   | ns   |
|                       |                   | see Figure 5                      | 10 V                               |                                      | 20  | 0   | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 15  | 0   | -   | ns   |
|                       |                   | $DS \to CP;$                      | 5 V                                |                                      | 30  | 15  | -   | ns   |
|                       |                   | see Figure 5                      | 10 V                               |                                      | 20  | 10  | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 15  | 7   | -   | ns   |
|                       |                   | $Dn \to CP;$                      | 5 V                                |                                      | 30  | 15  | -   | ns   |
|                       |                   | see Figure 5                      | 10 V                               |                                      | 20  | 10  | -   | ns   |
|                       |                   |                                   | 15 V                               |                                      | 15  | 7   | -   | ns   |
| f <sub>clk(max)</sub> | maximum clock     | see Figure 5                      | 5 V                                |                                      | 6   | 13  | -   | MHz  |
| /                     | frequency         |                                   | 10 V                               |                                      | 15  | 30  | -   | MHz  |
|                       |                   |                                   | 15 V                               |                                      | 20  | 40  | -   | MHz  |

<sup>[1]</sup> The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C<sub>L</sub> in pF).

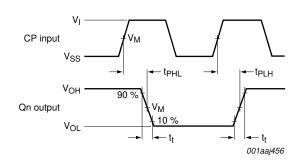
<sup>[2]</sup>  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

Table 8. Dynamic power dissipation P<sub>D</sub>

 $P_D$  can be calculated from the formulas shown.  $V_{SS} = 0 \ V$ ;  $t_r = t_f \le 20 \ ns$ ;  $T_{amb} = 25 \ ^{\circ}C$ .

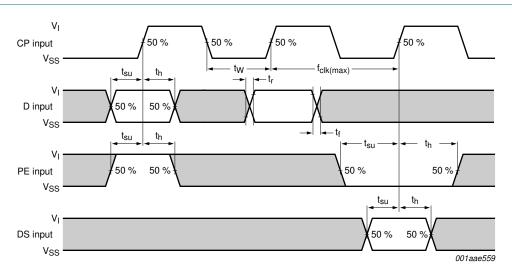
| Symbol      | Parameter     | $V_{DD}$ | Typical formula for P <sub>D</sub> (μW)                            | Where:   |
|-------------|---------------|----------|--|--|
| $P_D$       | dynamic power | 5 V      | $P_D = 900 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$   | f <sub>i</sub> = input frequency in MHz;       |
| dissipation |               | 10 V     | $P_D = 4300 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$  | fo = output frequency in MHz;                  |
|             |               | 15 V     | $P_D = 12000 \times f_i + \Sigma (f_0 \times C_L) \times V_{DD}^2$ | $C_L$ = output load capacitance in pF;         |
|             |               |          |  | $V_{DD}$ = supply voltage in V;                |
|             |               |          |  | $\Sigma(C_L \times f_o)$ = sum of the outputs. |

## 12. Waveforms



Measurement points are given in Table 9.

Fig 4. CP to Qn propagation delays and output transition times



The shaded areas indicate where change is permitted for predictable output performance.

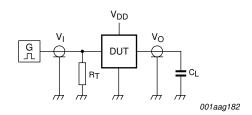
Set-up and hold times are shown as positive values but may be specified as negative values.

Measurement points are given in Table 9.

Fig 5. Minimum clock pulse width, and set-up and hold times for PE to CP, DS to CP, and D to CP

Table 9. Measurement points

| Supply voltage | Input              | Output             |
|----------------|--------------------|--------------------|
| $V_{DD}$       | V <sub>M</sub>     | V <sub>M</sub>     |
| 5 V to 15 V    | 0.5V <sub>DD</sub> | 0.5V <sub>DD</sub> |



Test data is given in Table 10;

Definitions for test circuit:

DUT = Device Under Test.

 $C_L$  = load capacitance including jig and probe capacitance.

 $R_T$  = termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

Fig 6. Test circuit

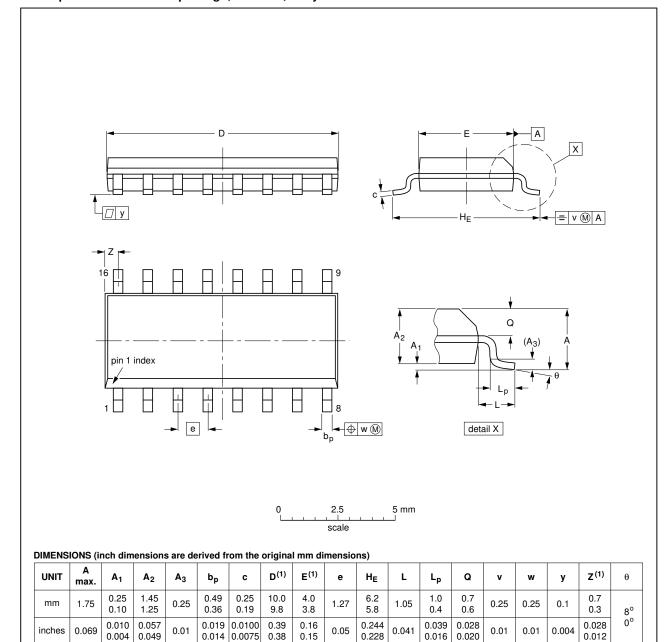
Table 10. Test data

| Supply voltage | Input                              |                                 | Load  |
|----------------|------------------------------------|---------------------------------|-------|
| $V_{DD}$       | VI                                 | t <sub>r</sub> , t <sub>f</sub> | CL    |
| 5 V to 15 V    | V <sub>SS</sub> or V <sub>DD</sub> | ≤ 20 ns                         | 50 pF |

# 13. Package outline

### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE REFERENCES |        |        |       |  | EUROPEAN   | ICCUE DATE                      |
|--------------------|--------|--------|-------|--|------------|---------------------------------|
| VERSION            | IEC    | JEDEC  | JEITA |  | PROJECTION | ISSUE DATE                      |
| SOT109-1           | 076E07 | MS-012 |       |  |            | <del>99-12-27</del><br>03-02-19 |

Fig 7. Package outline SOT109-1 (SO16)

HEF4014B-Q100

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# 14. Abbreviations

### Table 11. Abbreviations

| Acronym | Description             |
|---------|-------------------------|
| HBM     | Human Body Model        |
| ESD     | ElectroStatic Discharge |
| MM      | Machine Model           |
| MIL     | Military                |

# 15. Revision history

### Table 12. Revision history

| Document ID       | Release date | Data sheet status  | Change notice | Supersedes |
|-------------------|--------------|--------------------|---------------|------------|
| HEF4014B_Q100 v.1 | 20130227     | Product data sheet | -             | -          |

## 16. Legal information

#### 16.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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